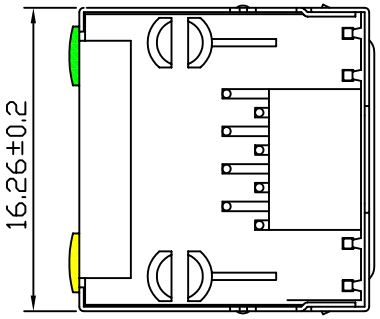
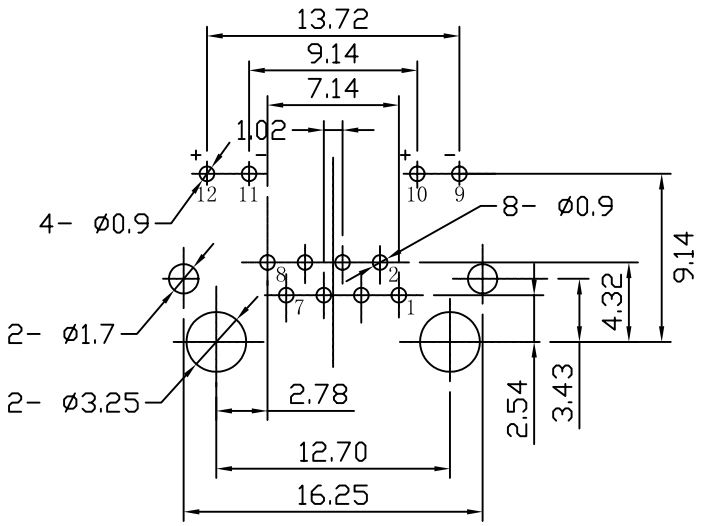
Mechanical:

REV.	ECN NO.	DESCRIPTION	DATE	APPD
A	REL		2010/07/22	

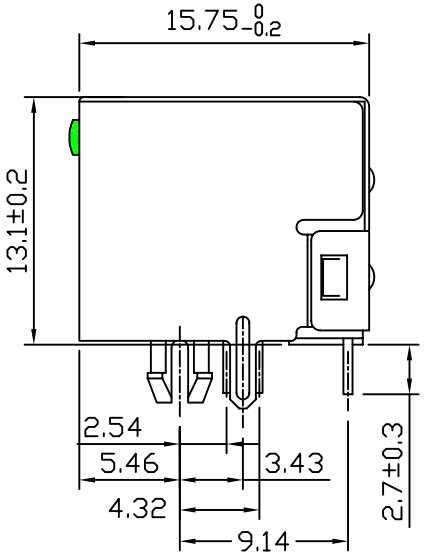


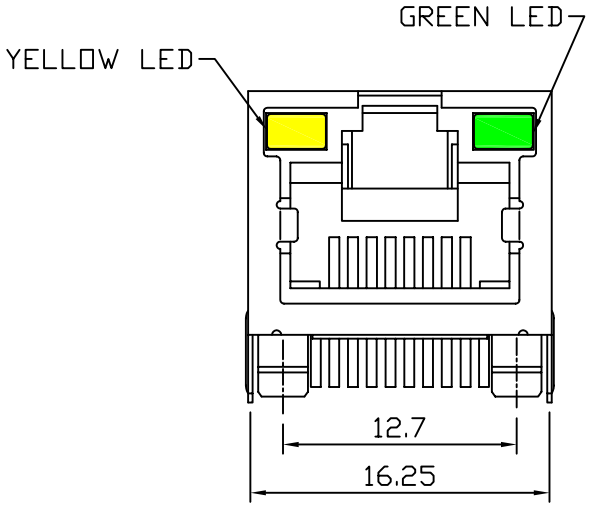


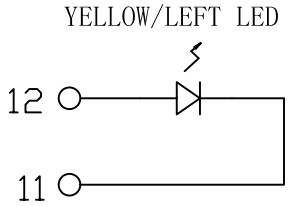
PC Board Layout(TOP VIEW)

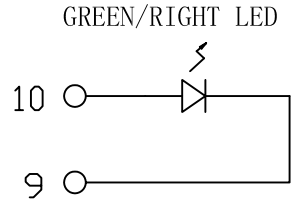
PCB JACK Specification

1. Insulation Resistance:500MΩMIN @ 500 VDC
2. Withstanding Voltage:AC1000V 50Hz or 60Hz 1min.
3. Durability:600 Mating Circles MIN.
4. Gold Plating:(Gold Flash;1.5;3;6;15;30;50)u inch
5. (1)Storage: -40℃ to +85℃
   (2)Opertion: -40℃ to +85℃
   (3)Wave solder temperture:230℃ to 250℃, 5～10 Sec.
6. UL Certification: File Number E321120.









RoHS 2002/95/EC

X:X ±0.25	APPD:	Trxcom ShenZhen Trxcom Electronics Co.,ltd	
X:XX ±0.10	CHKD:		
X:XXX ±0.05	DR: C.H.Y	TITLE: RJ45 1×1 CONNECTOR	
ANGLES ±1°	UNIT: mm	PART NO.: TRJE101BGNL	
	SCALE: 2/1	SHEET: 1/1	REV: A	DWG NO.: TRC10072201